

L Number	Hits	Search Text	DB	Time stamp
7	33	5426563.URPN.	USPAT	2003/07/16 15:11
8	13	5426563.URPN. and (cool\$3 with (liquid\$1 fluid\$1))	USPAT	2003/07/16 15:56
9	149	((printed with circuit with board\$1) semiconductor) with test\$3) and (cool\$3 (temperature with control\$4)) and ((test adj head) testhead)	USPAT	2003/07/16 15:59
10	51	((((printed with circuit with board\$1) semiconductor) with test\$3) and (cool\$3 (temperature with control\$4)) and ((test adj head) testhead)) and (computer)	USPAT	2003/07/16 16:00
11	7	(((((printed with circuit with board\$1) semiconductor) with test\$3) and (cool\$3 (temperature with control\$4)) and ((test adj head) testhead)) and (computer)) and (parallel with (board\$1 card\$1))	USPAT	2003/07/16 16:58
12	1	6052284.pn.	USPAT	2003/07/16 16:58
-	7	((printed with circuit\$2 with board\$1) (channel with card\$1)) and (semiconductor with (test\$3 cool\$3)) and ((board\$1 card\$1) with parallel) and ((board\$1 card\$1) with border)	USPAT	2003/07/16 11:35
-	389	((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((board\$1 card\$1) with parallel) and ((board\$1 card\$1) with (border seal))	USPAT	2003/07/14 11:19
-	31	((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((board\$1 card\$1) with parallel) and ((board\$1 card\$1) with (border seal))) and (semiconductor with (test\$3 cool\$3))	USPAT	2003/07/14 11:21
-	0	((((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((board\$1 card\$1) with parallel) and ((board\$1 card\$1) with (border seal))) and ((liquid air) with tight with (container border seal mount\$3))) and (semiconductor with (test\$3 cool\$3))	USPAT	2003/07/14 11:21
-	14	((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((board\$1 card\$1) with parallel) and ((board\$1 card\$1) with (border seal))) and ((liquid air) with tight with (container border seal mount\$3))	USPAT	2003/07/14 11:23
-	0	((((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((board\$1 card\$1) with parallel) and ((board\$1 card\$1) with (border seal))) and (semiconductor with (test\$3 cool\$3))) and ((liquid air) with tight with (container border seal mount\$3))	USPAT	2003/07/14 11:23
-	12	((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((board\$1 card\$1) with parallel with mount\$3) and ((seal border) with (air liquid) with tight)	USPAT	2003/07/14 11:28
-	14	((printed with circuit\$2 with board\$1) (channel with card\$1)) and ((semiconductor\$1 board\$1 card\$1) with (stack\$4 parallel) with mount\$3) and ((seal border) with (air liquid) with tight)	USPAT	2003/07/14 11:34
-	27	(parallel with circuit\$2 with board\$1) and (liquid with tight with (border wall seal\$1))	USPAT	2003/07/14 11:42

	0	((parallel with circuit\$2 with board\$1) and (liquid with tight with (border wall seal\$1))) and (non-conduct\$3 with (liquid\$1 fluid\$1))	USPAT	2003/07/14 11:43
	7	((parallel with circuit\$2 with board\$1) and (liquid with tight with (border wall seal\$1))) and ((insulat\$3 cool\$3) with (liquid\$1 fluid\$1))	USPAT	2003/07/14 12:09
	4	(semiconductor with test\$3 with cool\$3) and (parallel with ((circuit with board\$1) (channel with card\$1) (circuit with card\$1)))	USPAT	2003/07/14 12:13
	3	((semiconductor with test\$3 with cool\$3) and (parallel with ((circuit with board\$1) (channel with card\$1) (circuit with card\$1)))) and ((liquid\$1 fluid\$1) with cool\$3)	USPAT	2003/07/15 12:06
	7	6052284.URPN.	USPAT	2003/07/15 11:22
	279	(printed with circuit with cool\$3) and ((liquid cool\$3 fluid) with (chamber container))	USPAT	2003/07/14 12:27
	23	((printed with circuit with cool\$3) and ((liquid cool\$3 fluid) with (chamber container))) and ((chamber container) with (boundary wall border)) and (parallel with (board\$1 semiconductor\$1 card\$1))	USPAT	2003/07/14 12:29
	3	((printed with circuit with cool\$3) and ((liquid cool\$3 fluid) with (chamber container))) and ((chamber container) with (boundary wall border)) and (parallel with (board\$1 semiconductor\$1 card\$1)) and (non with conduct\$4 with (liquid\$1 fluid\$1 coolant))	USPAT	2003/07/14 12:30
	23	("4092697"   "4138692"   "4381032"   "4531146"   "4807019"   "4879629"   "5195020"   "5224017"   "5294830"   "5306866"   "5349498"   "5388635"   "5638597"   "5656862"   "5658831"   "5668059"   "5727310"   "5786629"   "5838060"   "6052284"   "6165596"   "6208517"   "6271058").PN.	USPAT	2003/07/15 11:18
	15	("("4092697"   "4138692"   "4381032"   "4531146"   "4807019"   "4879629"   "5195020"   "5224017"   "5294830"   "5306866"   "5349498"   "5388635"   "5638597"   "5656862"   "5658831"   "5668059"   "5727310"   "5786629"   "5838060"   "6052284"   "6165596"   "6208517"   "6271058").PN.) and (cool\$3 with (fluid\$1 liquid\$1))	USPAT	2003/07/15 11:22
	4	("("4092697"   "4138692"   "4381032"   "4531146"   "4807019"   "4879629"   "5195020"   "5224017"   "5294830"   "5306866"   "5349498"   "5388635"   "5638597"   "5656862"   "5658831"   "5668059"   "5727310"   "5786629"   "5838060"   "6052284"   "6165596"   "6208517"   "6271058").PN.) and (cool with (fluid\$1 liquid\$1))	USPAT	2003/07/15 11:46
	4	(second with circuit with board) and (parallel\$2 with mount\$3 with board\$1) and ((liquidtight (liquid adj tight) (air adj tight)) with (border boundary wall container))	USPAT	2003/07/15 14:09
	332	first with second with circuit\$1 with boards\$1 with parallel\$3	USPAT	2003/07/15 14:11

	30	((first with second with circuit\$1 with boards\$1 with parallel\$3) and (first and second with (border boundary wall) with (between interposed connecting)))	USPAT	2003/07/15 14:20
	31	((first with second with circuit\$1 with boards\$1 with parallel\$3) and (first and second with (border boundary wall seal) with (between interposed connecting)))	USPAT	2003/07/15 14:27
	0	((first with second with circuit\$1 with boards\$1 with parallel\$3) and (first and second with (border boundary wall seal) with (between interposed connecting))) and ((liquidtight (liquid adj tight) (air adj tight)) with (border boundary wall container seal))	USPAT	2003/07/15 14:27
	0	((first with second with circuit\$1 with boards\$1 with parallel\$3) and (first and second with (border boundary wall seal) with (between interposed connecting))) and (liquidtight (liquid adj tight) (air adj tight))	USPAT	2003/07/15 14:22
	14	((first with second with circuit\$1 with boards\$1 with parallel\$3) and (first and second with (border boundary wall seal) with (between interposed connecting))) and (liquid\$1 fluid\$1)	USPAT	2003/07/15 14:28
	4	((first with second with circuit\$1 with boards\$1 with parallel\$3) and (first and second with (border boundary wall seal) with (between interposed connecting))) and ((liquid\$1 fluid\$1) with cool\$3)	USPAT	2003/07/15 14:29
	72	((liquid\$1 fluid\$1) with cool\$3 with parallel with ((circuit adj board\$1) semiconductor\$1))	USPAT; EPO; JPO; DERWENT	2003/07/15 14:39
	15	((liquid\$1 fluid\$1) with cool\$3 with parallel with ((circuit adj board\$1) semiconductor\$1)) and ((border seal wall) with (between interposed seperat\$3))	USPAT; EPO; JPO; DERWENT	2003/07/15 14:41
	3	5835349.URPN.	USPAT	2003/07/15 16:39
	24	(border wall seal) with (between interposed) with parallel with ((circuit adj boards) (channel adj card\$1) pcb\$2)	USPAT	2003/07/15 17:16
	2	((border wall seal) with (between interposed) with parallel with ((circuit adj boards) (channel adj card\$1) pcb\$2)) and ((liquid\$1 fluid\$1) with cool\$3)	USPAT	2003/07/15 17:18
	11	(parallel with circuit with board\$1 with form\$3 with (liquid\$1 fluid\$1) with (chamber container cool\$3))	USPAT; EPO; JPO; DERWENT	2003/07/15 17:47
	28	printed with circuit with board\$1 with test\$3 with cool\$3	USPAT	2003/07/16 11:42
	110	324/514.cccls.	USPAT	2003/07/16 11:37
	0	324/514.cccls. and (printed with circuit\$2 with board\$1) and ((liquid\$1 fluid\$1) with Cool\$3)	USPAT	2003/07/16 11:38
	3	324/514.cccls. and ((liquid\$1 fluid\$1) with Cool\$3)	USPAT	2003/07/16 11:38
	7	324/514.cccls. and (printed with circuit\$2 with board\$1)	USPAT	2003/07/16 11:39
	534	(printed with circuit with board\$1) and (test\$3 with cool\$3)	USPAT	2003/07/16 11:43
	15	((printed with circuit with board\$1) and (test\$3 with cool\$3)) and (second with circuit with board\$1) and ((border seal wall) with (between interposed connect\$3))	USPAT	2003/07/16 11:48

-	7	((printed with circuit with board\$1) and (test\$3 with cool\$3)) and (second with circuit with board\$1) and ((border seal wall) with (between interposed connect\$3))) and (liquid\$1 fluid\$1) ((semiconductor\$1 substrate) with parallel with form\$3 with ((liquid\$1 fluid\$1) with cool\$3))	USPAT	2003/07/16 12:22
-	28		USPAT	2003/07/16 12:24
-	7	((semiconductor\$1 substrate) with parallel with form\$3 with ((liquid\$1 fluid\$1) with cool\$3))) and (test\$3)	USPAT	2003/07/16 15:11